

# DATA SHEET ANTI SURGE AND ANTI SULFURATION AUTOMOTIVE GRADE CHIP RESISTORS

AS series 0.5%, 1%, 5%, 10%, 20% sizes 0603/0805/1206

RoHS compliant & Halogen free



Product specification – August 3, 2022 V.2



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#### <u>SCOPE</u>

This specification describes AS0603 to AS1206 chip resistors with lead-free terminations made by thick film process.

#### **APPLICATIONS**

- Telecommunications
- Power supplies
  Car electronics

#### FEATURES

- AEC-Q200 qualified
- Superior to AF series in pulse withstanding voltage and surge withstanding voltage.
- MSL class: MSL I
- Halogen free epoxy
- RoHS compliant
- Reduce environmentally hazardous waste
- High component and equipment reliability

#### ORDERING INFORMATION - GLOBAL PART NUMBER

Part number is identified by the series name, size, tolerance, packaging type, temperature coefficient, taping reel and resistance value.

#### **GLOBAL PART NUMBER**

# AS XXXX X X X XX XXXX L

(1)	(2) (3) (4)	(5)	(6)	(7)	
(I) SIZE					
0603 / 08	805 / 1206				

#### (2) TOLERANCE

$D = \pm 0.5\%$
$F = \pm 1\%$
$J = \pm 5\%$
$K = \pm 10\%$
$M = \pm 20\%$

#### (3) PACKAGING TYPE

R = Paper taping reel

#### (4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Based on spec.

#### (5) TAPING REEL & POWER

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07 = 7 inch dia. Reel 7W = 7 inch dia. Reel & 2 x standard power
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7T = 7 inch dia. Reel & 3 × standard power

47 = 7 inch dia. Reel & 4 × standard power

# (6) RESISTANCE VALUE

#### $\mid \Omega \leq R \leq \mid M \mid \Omega$

There are  $2\sim4$  digits indicated the resistance value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. IK2, not IK20.

Detailed coding rules of resistance are shown in the table of "Resistance rule of global part number".

#### (7) DEFAULT CODE

Letter L is the system default code for ordering only. <sup>(Note)</sup>

Resistance rule of global part				
Resistance coding rule	Example			
XRXX	$IR = I \Omega$ $IR5 = 1.5 \Omega$			
(I to 9.76 Ω)	$9R76 = 9.76 \Omega$			
XXRX	10R = 10 Ω			
(10 to 97.6 Ω)	97R6 = 97.6 Ω			
XXXR (100 to 976 Ω <b>)</b>	100R = 100 Ω			
XKXX	IK = 1,000 Ω			
(Ι to 9.76 K <b>Ω)</b>	9K76 = 9760 Ω			
XXKX	$10K = 10,000 \Omega$			
(10 to 97.6 K <b>Ω)</b>	97K6= 976,000 Ω			
XXXK (100 KΩ <b>)</b>	100K = 100,000 Ω			

#### ORDERING EXAMPLE

The ordering code for an AS0805 chip resistor, value 10 K $\Omega$  with ±5% tolerance, supplied in 7-inch tape reel is: AS0805JR-0710KL.

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MARKING	
AS0603	
<b>Fig. I</b> Value = 24 $\Omega$	1%, 0.5%,E24 exception values 10/11/13/15/20/75 of E24 series
<b>Fig. 2</b> Value = 806 Ω	1%, 0.5%, E96 refer to EIA-96 marking method, including values 10/11/13/15/20/75 of E24 series
AS0805 / 1206	
<b>Fig. 3</b> Value = 10 K Ω	Both E-24 and E-96 series: 4 digits, $\pm$ 0.5% & $\pm$ 1% First three digits for significant figure and 4th digit for number of zeros

# ΝΟΤΕ

For further marking information, please refer to data sheet "Chip resistors marking".

# TAPING REEL & POWER

Table I

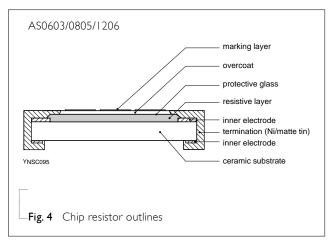
		F	POWER, W (P70)		
TYPE			CODING		
	07	7W	7T	47	
0603	1/10	1/5	1/4	-	
0805	1/8	1/4	1/3	1/2	
1206	1/4	1/2	3/4	-	



#### CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive glaze. The resistive glaze is covered by a lead-free glass. The composition of the glaze is adjusted to give the approximately required resistance value. The whole element is covered by a protective overcoat. The top of overcoat is marked with the resistance value. Finally, the two external terminations (Ni/matte tin) are added, as shown in Fig.4.

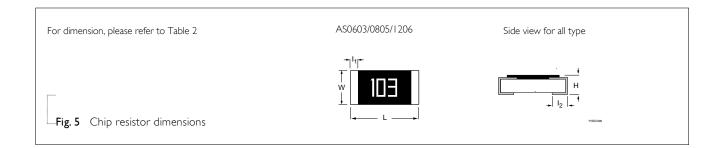
# OUTLINES



#### **DIMENSIONS**

#### Table 2

ТҮРЕ	L (mm)	W (mm)	H (mm)	I⊤ (mm)	l <sub>2</sub> (mm)
AS0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
AS0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
AS1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.45±0.20





# ELECTRICAL CHARACTERISTICS

Table 3

				C		RISTICS	
TYPE	POWER	RESISTANCE RANGE	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
	1/10W						
AS0603	1/5W			75V	150V	150V	
	1/4W		_				
	1/8W	E24 5%, 10%, 20%					$ \Omega \le R \le  0\Omega $
AS0805	1/4W	$ \Omega \leq R \leq  M\Omega $	–55 ℃ to +155 ℃		2001/	2001/	± 200 ppm°C
A30003	1/3W	E24/E96 0.5%, 1%	-55 C 10 (155 C	150V	300V	300V	$10\Omega < R \le 1M\Omega$
	1/2W	$ \Omega \leq R \leq  M\Omega $					± 100 ppm°C
	1/4W						
AS1206	1/2W			200 V	400 V	500V	
	3/4W						

# FOOTPRINT AND SOLDERING PROFILES

Recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting".

# PACKING STYLE AND PACKAGING QUANTITY

Table 4	Packing style and pack	aging quantity
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PACKING STYLE	REEL DIMENSION	AS0603/0805/1206
Paper taping reel (R)	7" (178 mm)	5,000

#### ΝΟΤΕ

I. For paper/embossed tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".



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#### FUNCTIONAL DESCRIPTION

# **OPERATING TEMPERATURE RANGE**

#### Range: –55 °C to +155 °C

#### **POWER RATING**

Each type rated power at 70 °C: AS0603: I/10W, I/5W, I/4W AS0805: I/8W, I/4W, I/3W, I/2W AS1206: I/4W, I/2W, 3/4W

#### **RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

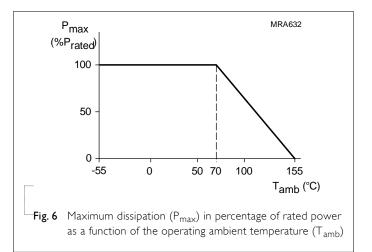
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or max. working voltage whichever is less Where

V = Continuous rated DC or AC (rms) working voltage (V)

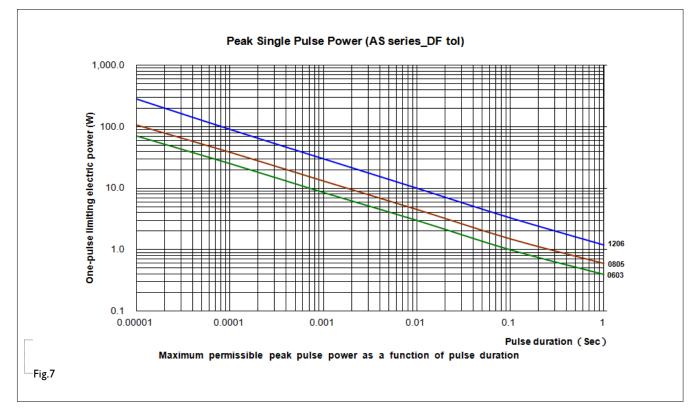
P = Rated power (W)

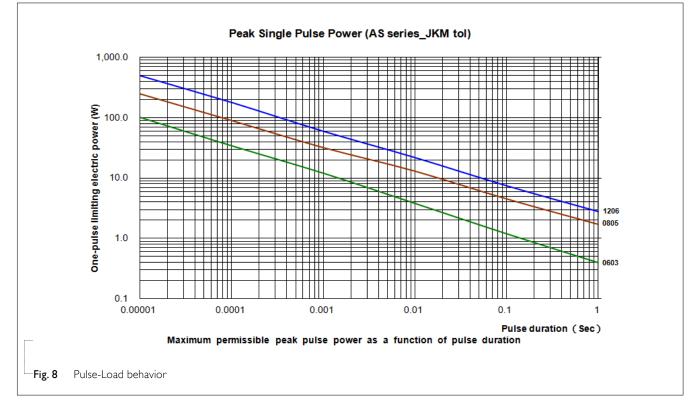
 $R = Resistance value (\Omega)$ 





# PULSE LOAD BEHAVIOR





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# TESTS AND REQUIREMENTS

Table 5 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
High Temperature Exposure			$\pm(1.0\%+0.05\Omega)$ for D/F tol $\pm(2.0\%+0.05\Omega)$ for J tol
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	±(0.5%+0.05Ω) for D/F tol ±(2.0%+0.05Ω) for J tol
Biased    AEC-Q200 Test 7    I,000 hours; 85 °C / 85% RH      Humidity    MIL-STD-202 Method 103    I0% of operating power      Measurement at 24±4 hours after test concl			$\pm(1.0\%+0.05\Omega)$ for D/F tol $\pm(3.0\%+0.05\Omega)$ for J tol
Operational Life	AEC-Q200 Test 8 MIL-STD-202 Method 108	1,000 hours at 125 °C, derated voltage applied for 1.5 hours on, 0.5 hour off, still-air required	±(1.0%+0.05Ω) for D/F tol ±(3.0%+0.05Ω) for J tol
Resistance to Soldering Heat	AEC-Q200 Test 15 MIL-STD-202 Method 210	Condition B, no pre-heat of samples Lead-free solder, 260±5 °C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	$\pm$ (0.5%+0.05Ω) for D/F tol $\pm$ (1.0%+0.05Ω) for J tol No visible damage
Thermal Shock	MIL-STD-202 Method 107	-55/+125 °C Number of cycles is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	±(0.5%+0.05Ω) for D/F tol ±(1.0%+0.05Ω) for J tol
ESD	AEC-Q200 Test 17 AEC-Q200-002	Human Body Model, I <sub>pos.</sub> + I <sub>neg.</sub> discharges 0201: 500V 0402/0603: IKV 0805 and above: 2KV	±(3.0%+0.05Ω)



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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	AEC-Q200 Test 18 J-STD-002	Electrical Test not required Magnification 50X SMD conditions:	Well tinned (≥95% covered) No visible damage
		(a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds.	0
		(b) Method B, steam aging 8 hours, dipping at 215±3 °C for 5±0.5 seconds.	
		(c) Method D, steam aging 8 hours, dipping at 260±3 °C for 30±0.5 seconds.	
Board Flex	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 100mm × 40mm glass epoxy resin PCB (FR4)	±(1.0%+0.05Ω)
		Bending for 0201/0402: 5 mm 0603/0805: 3 mm 1206 and above: 2 mm	
		Holding time: minimum 60 seconds	
Temperature Coefficient of	MIL-STD-202 Method 304	At +25/–55 °C and +25/+125 °C	Refer to table 3
Resistance (T.C.R.)		Formula:	
		T.C.R= $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where	
		$t_1$ =+25 °C or specified room temperature	
		$t_2 = -55$ °C or +125 °C test temperature	
		$R_{I}$ =resistance at reference temperature in ohms	
		R <sub>2</sub> =resistance at test temperature in ohms	
Short Time	IEC60115-18.1	2.5 times of rated voltage or maximum	$\pm$ (1.0%+0.05 $\Omega$ ) for D/F tol
Overload		overload voltage whichever is less for 5 sec at room temperature	$\pm(2.0\%{+}0.05\Omega)$ for J tol
FOS	ASTM-B-809-95*	Sulfur 750 hours, 105 °C, unpowered	± (4.0%+0.05Ω)
	* Modified		



# <u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Aug. 03, 2022	-	- 12 dimension updated, for size I 206.
Version I	Apr. 08, 2021	-	- Upgrade to Automotive Grade
Version 0	Nov. 30, 2020	-	- New product datasheet



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